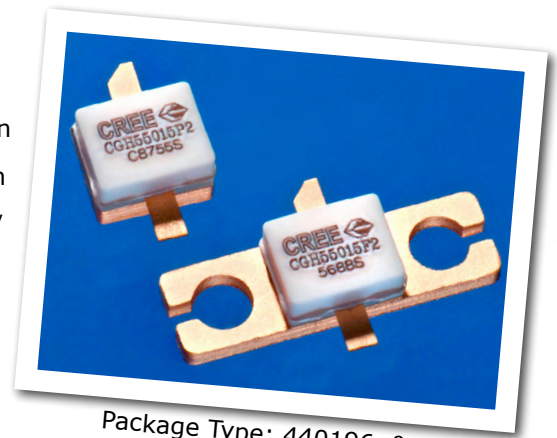


CGH55015F2 / CGH55015P2

10 W, C-band, Unmatched, GaN HEMT

Cree's CGH55015F2/CGH55015P2 is a gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically for high efficiency, high gain and wide bandwidth capabilities, which makes the CGH55015F2/CGH55015P2 ideal for C-band pulsed or CW saturated amplifiers. The transistor is available in both screw-down, flange and solder-down, pill packages. Based on appropriate external match adjustment, the CGH55015F2/CGH55015P2 is suitable for applications up to 6 GHz.



Package Type: 440196 & 440166
PN: CGH55015P2 & CGH55015F2

FEATURES

- 4.5 to 6.0 GHz Operation
- 12 dB Small Signal Gain at 5.65 GHz
- 13 W typical P_{SAT}
- 60 % Efficiency at P_{SAT}
- 28 V Operation

APPLICATIONS

- 2-Way Private Radio
- Broadband Amplifiers
- Cellular Infrastructure
- Test Instrumentation
- Class A, AB Amplifiers for Drivers and Gain Blocks



Large Signal Models Available for SiC & GaN



Absolute Maximum Ratings (not simultaneous) at 25 °C Case Temperature

| Parameter | Symbol | Rating | Units | Conditions |
|---|-----------------|-----------|-------|------------|
| Drain-Source Voltage | V_{DS} | 84 | Volts | 25 °C |
| Gate-to-Source Voltage | V_{GS} | -10, +2 | Volts | 25 °C |
| Storage Temperature | T_{STG} | -65, +150 | °C | |
| Operating Junction Temperature | T_J | 225 | °C | |
| Maximum Forward Gate Current | I_{GMAX} | 4.0 | mA | 25 °C |
| Maximum Drain Current ¹ | I_{DMAX} | 1.5 | A | 25 °C |
| Soldering Temperature ² | T_S | 245 | °C | |
| Screw Torque | τ | 60 | in-oz | |
| Thermal Resistance, Junction to Case ³ | $R_{\theta JC}$ | 8.0 | °C/W | 85 °C |
| Case Operating Temperature ^{3,4} | T_C | -40, +150 | °C | 30 seconds |

Note:

¹ Current limit for long term, reliable operation.

² Refer to the Application Note on soldering at www.cree.com/products/wireless_appnotes.asp

³ Measured for the CGH55015 at $P_{DISS} = 14W$.

⁴ See also, the Power Dissipation De-rating Curve on Page 5.

Electrical Characteristics ($T_C = 25^\circ C$)

| Characteristics | Symbol | Min. | Typ. | Max. | Units | Conditions |
|--|--------------|------|------|--------|----------|--|
| DC Characteristics¹ | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | -3.8 | -3.0 | -2.3 | V_{DC} | $V_{DS} = 10 V, I_D = 3.6 mA$ |
| Gate Quiescent Voltage | $V_{GS(Q)}$ | - | -2.7 | - | V_{DC} | $V_{DS} = 28 V, I_D = 200 mA$ |
| Saturated Drain Current | I_{DS} | 2.9 | 3.5 | - | A | $V_{DS} = 6.0 V, V_{GS} = 2.0 V$ |
| Drain-Source Breakdown Voltage | V_{BR} | 120 | - | - | V_{DC} | $V_{GS} = -8 V, I_D = 3.6 mA$ |
| RF Characteristics² ($T_C = 25^\circ C, F_0 = 5.65 GHz$ unless otherwise noted) | | | | | | |
| Small Signal Gain | G_{SS} | 10 | 12 | - | dB | $V_{DD} = 28 V, I_{DQ} = 200 mA$ |
| Power Output ³ | P_{SAT} | 10 | 12.5 | - | W | $V_{DD} = 28 V, I_{DQ} = 200 mA$ |
| Drain Efficiency ⁴ | η | 50 | 60 | - | % | $V_{DD} = 28 V, I_{DQ} = 200 mA, P_{OUT} = 10 W$ |
| Output Mismatch Stress | VSWR | - | - | 10 : 1 | Ψ | No damage at all phase angles, $V_{DD} = 28 V, I_{DQ} = 200 mA,$ $P_{OUT} = 10 W CW$ |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | C_{GS} | - | 4.5 | - | pF | $V_{DS} = 28 V, V_{gs} = -8 V, f = 1 MHz$ |
| Output Capacitance | C_{DS} | - | 1.3 | - | pF | $V_{DS} = 28 V, V_{gs} = -8 V, f = 1 MHz$ |
| Feedback Capacitance | C_{GD} | - | 0.2 | - | pF | $V_{DS} = 28 V, V_{gs} = -8 V, f = 1 MHz$ |

Notes:

¹ Measured on wafer prior to packaging.

² Measured in CGH55015-TB.

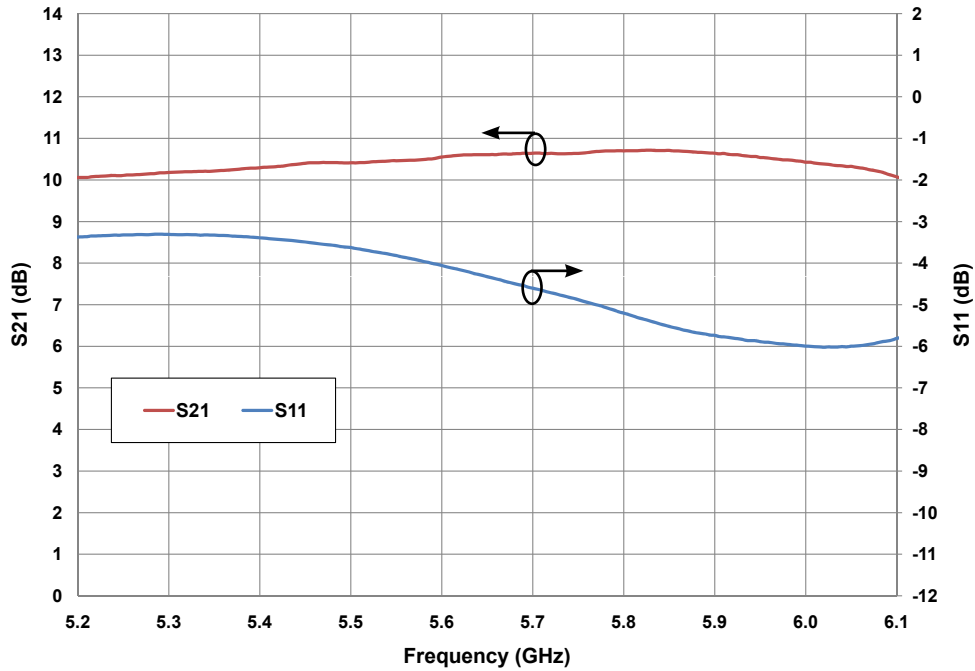
³ P_{SAT} is defined as $I_G = 0.36 mA$.

⁴ Drain Efficiency = P_{OUT} / P_{DC}

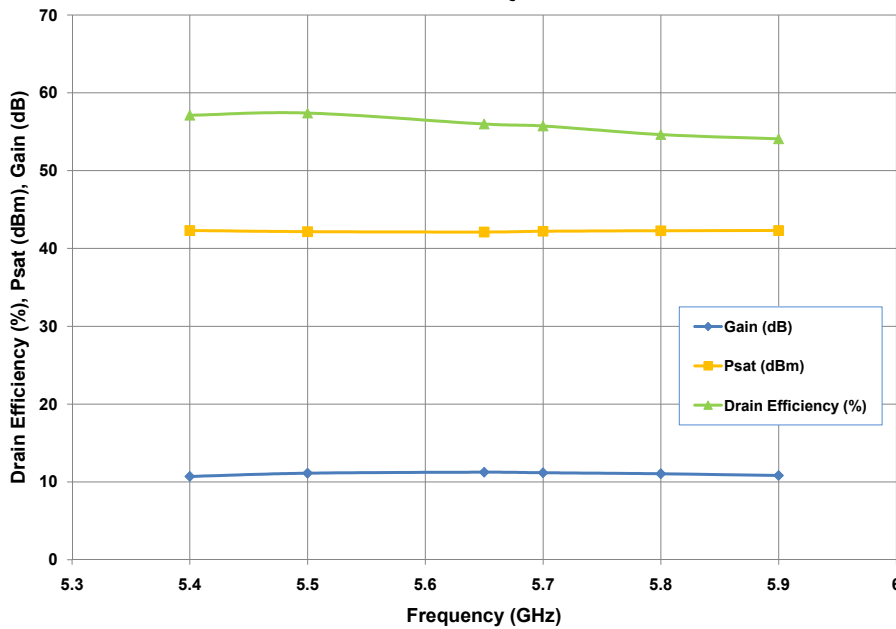


Typical Performance

**Small Signal S-Parameters vs Frequency of
CGH55015F2 and CGH55015P2 in the CGH55015-TB**
 $V_{DD} = 28\text{ V}$, $I_{DQ} = 200\text{ mA}$

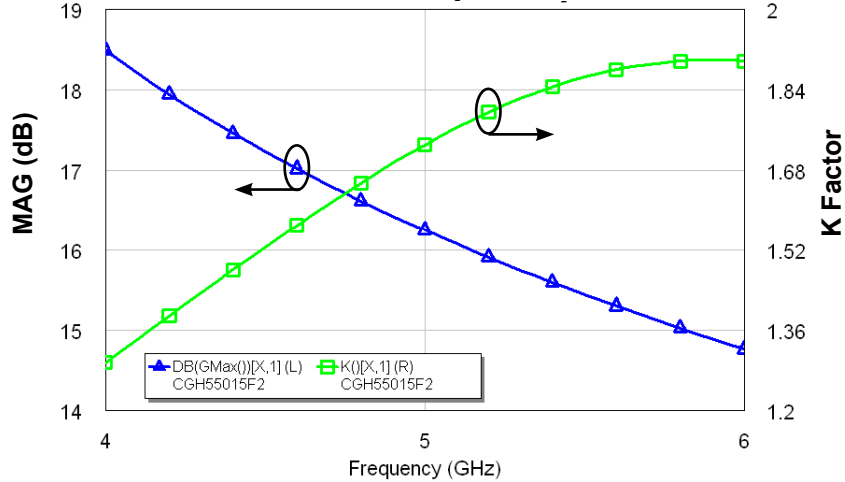


**Drain Efficiency, Power and Gain vs Frequency of the
CGH55015F2 and CGH55015P2 in the CGH55015-TB**
 $V_{DD} = 28\text{ V}$, $I_{DQ} = 200\text{ mA}$



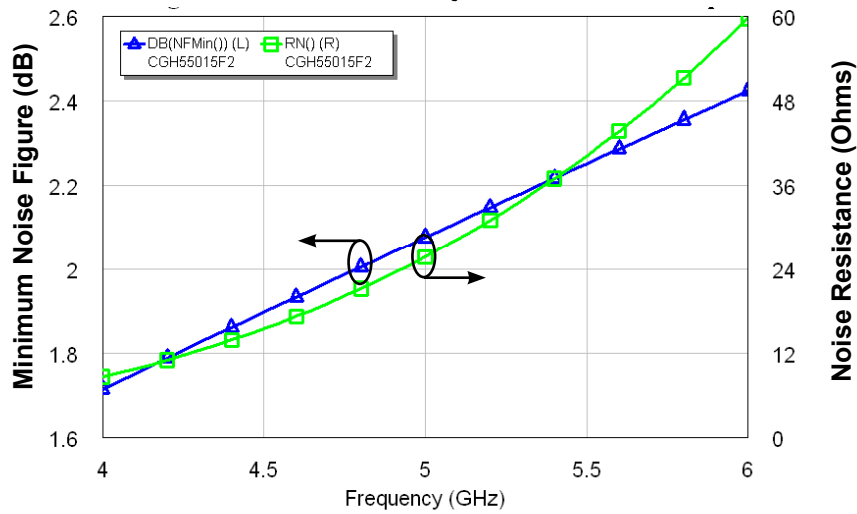
Typical Performance

Simulated Maximum Available Gain and K Factor of the CGH55015F2/CGH55015P2
 $V_{DD} = 28\text{ V}, I_{DQ} = 200\text{ mA}$



Typical Noise Performance

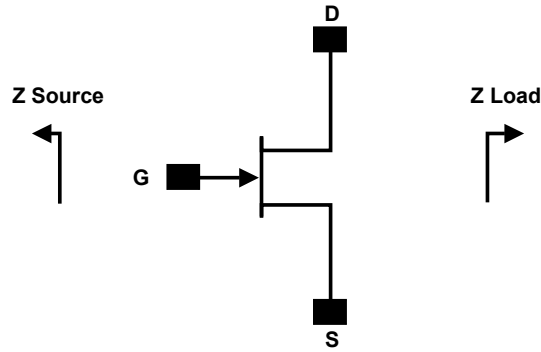
Simulated Minimum Noise Figure and Noise Resistance vs Frequency of the CGH55015F2/CGH55015P2
 $V_{DD} = 28\text{ V}, I_{DQ} = 200\text{ mA}$



Electrostatic Discharge (ESD) Classifications

| Parameter | Symbol | Class | Test Methodology |
|---------------------|--------|------------|---------------------|
| Human Body Model | HBM | 1A > 250 V | JEDEC JESD22 A114-D |
| Charge Device Model | CDM | 1 < 200 V | JEDEC JESD22 C101-C |

Source and Load Impedances

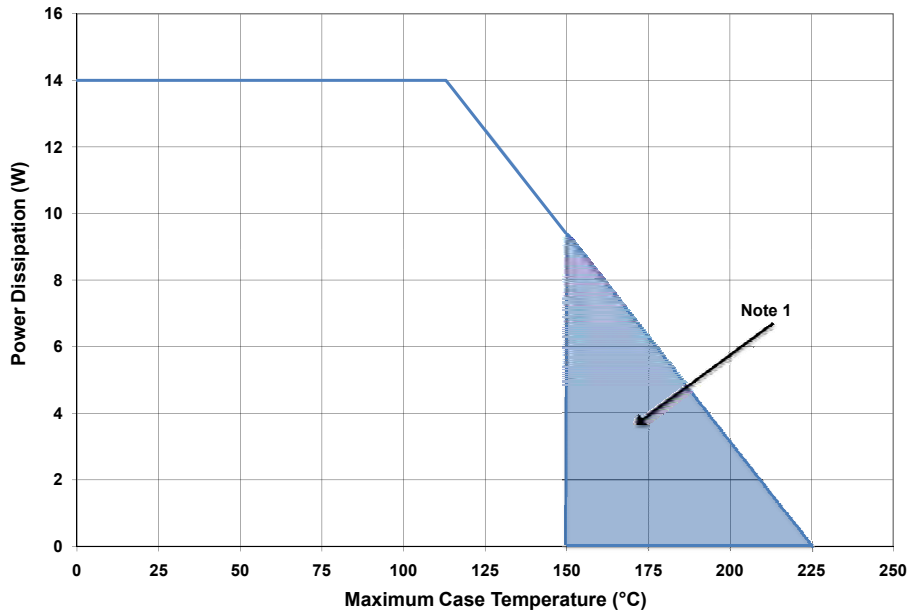


| Frequency (MHz) | Z Source | Z Load |
|-----------------|--------------|-------------|
| 5500 | 8.7 - j30.2 | 21.6 - j4.7 |
| 5650 | 10.2 - j26.9 | 24.2 - j5.5 |
| 5800 | 12.3 - j24.3 | 26.5 - j7.5 |

Note 1. $V_{DD} = 28V$, $I_{DQ} = 200\text{ mA}$ in the 440166 package.

Note 2. Impedances are extracted from the CGH55015-TB demonstration amplifier and are not source and load pull data derived from the transistor.

CGH55015F2 and CGH55015P2 Power Dissipation De-rating Curve

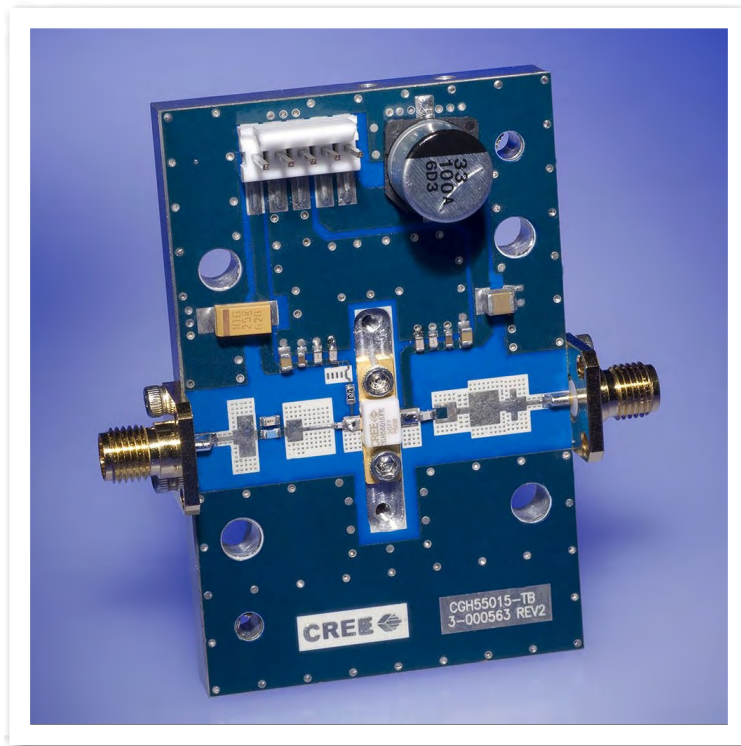


Note 1. Area exceeds Maximum Case Operating Temperature (See Page 2).

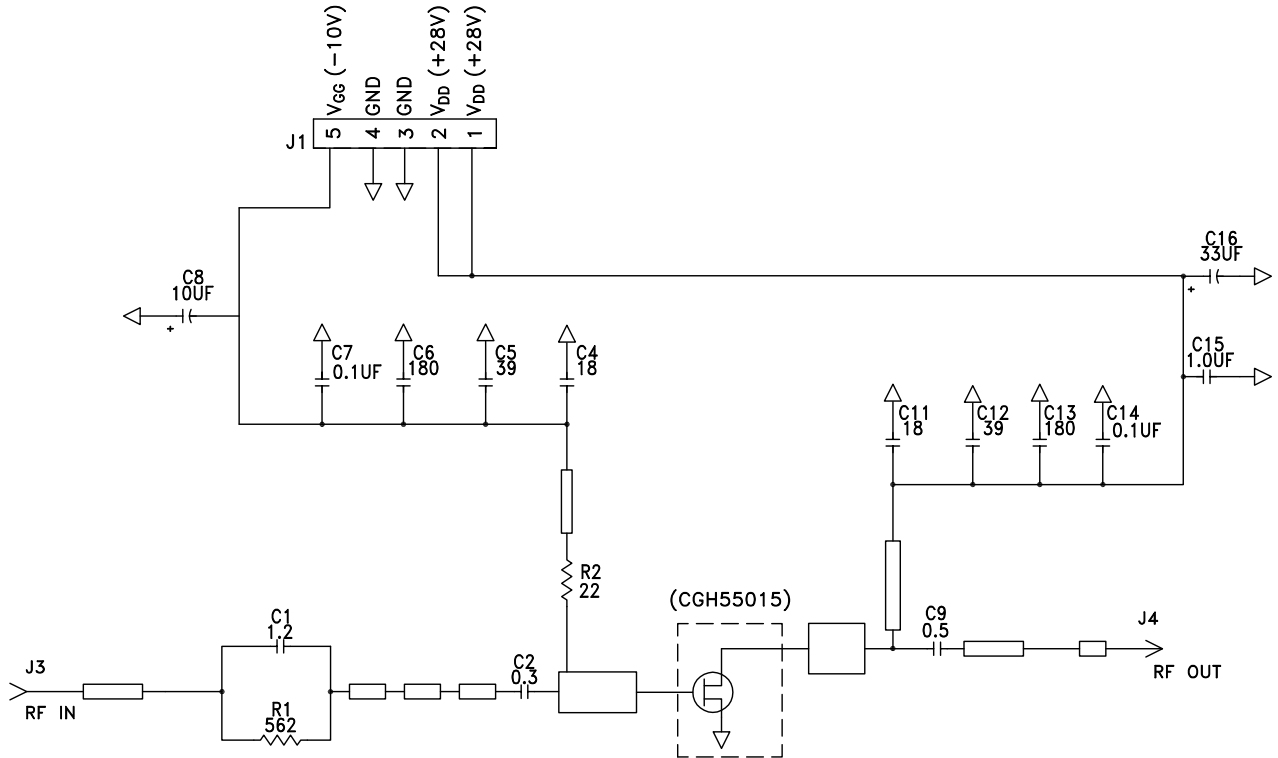
CGH55015-TB Demonstration Amplifier Circuit Bill of Materials

| Designator | Description | Qty |
|------------|---|-----|
| C1 | CAP, 1.2pF, +/-0.1 pF, 0603, ATC 600S | 1 |
| C2 | CAP, 0.3pF, +/-0.05 pF, 0402, ATC 600L | 1 |
| C9 | CAP, 0.5pF, +/-0.05pF, 0603, ATC 600S | 1 |
| C4,C11 | CAP, 18pF, +/-5%, 0603, ATC 600S | 2 |
| C5,C12 | CAP, 39pF +/-5%, 0603, ATC 600S | 2 |
| C6,C13 | CAP, CER, 180pF, 50V, +/-5%, COG, 0603 | 2 |
| C7,C14 | CAP, CER, 0.1UF, 50V, +/-10%, X7R, 0805 | 2 |
| C8 | CAP, 10UF, 16V, SMT, TANTALUM | 1 |
| C15 | CAP, 1.0UF ±10%, 100V, 1210, X7R | 1 |
| C16 | CAP, 33UF, 100V, ELECT, FK, SMD | 1 |
| R1 | RES, 1/16W, 0603, 1%, 562 OHMS | 1 |
| R2 | RES, 1/16W, 0603, 1%, 22 OHMS | 1 |
| J1 | HEADER RT> PLZ .1 CEN LK 5 POS | 1 |
| J3,J4 | CONN, SMA, FLANGE | 2 |
| - | PCB, RO4350B, Er = 3.48, h = 20 mil | 1 |
| - | CGH55015 | 1 |

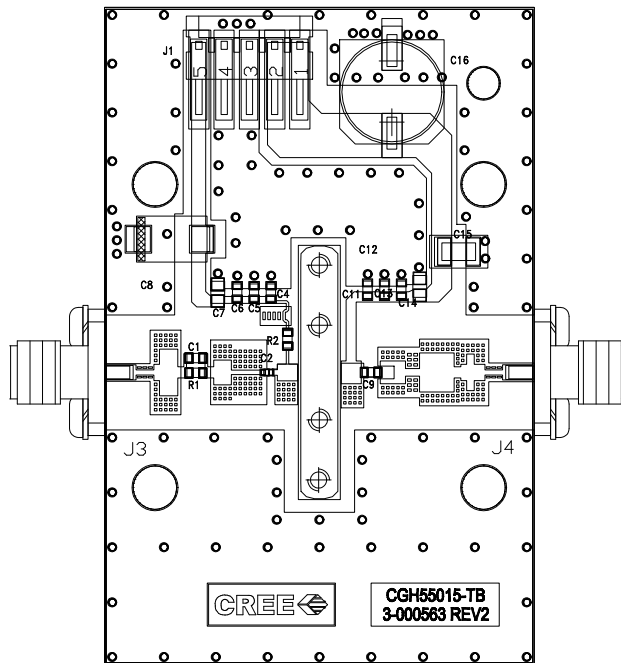
CGH55015-TB Demonstration Amplifier Circuit



CGH55015-TB Demonstration Amplifier Circuit Schematic



CGH55015-TB Demonstration Amplifier Circuit Outline



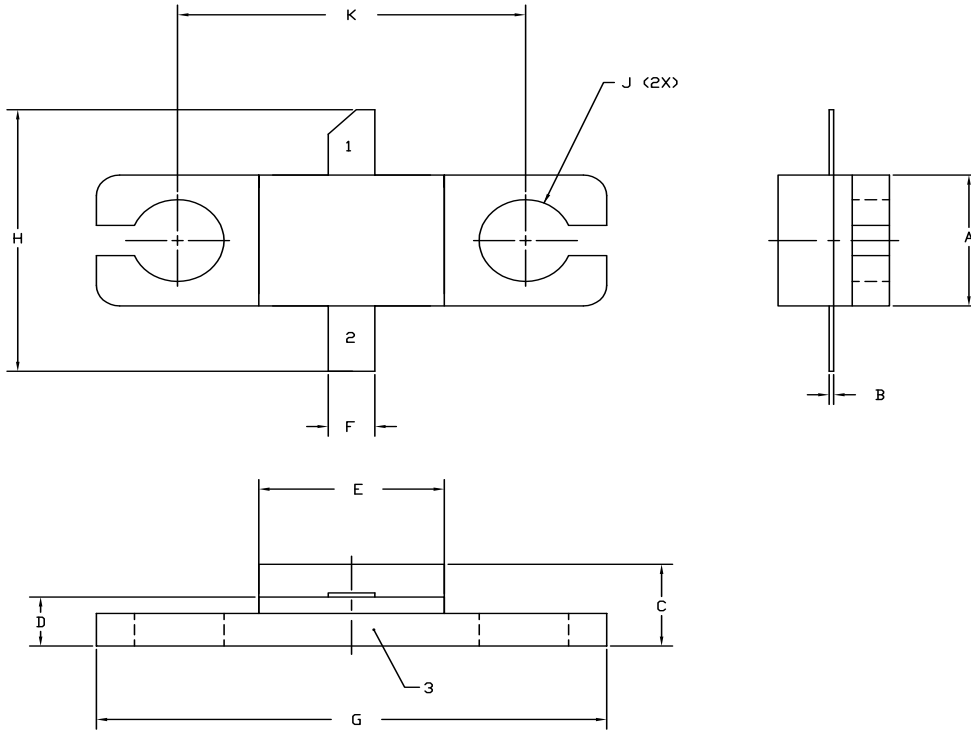


Typical Package S-Parameters for CGH55015F2 / CGH55015P2
 (Small Signal, $V_{DS} = 28\text{ V}$, $I_{DQ} = 200\text{ mA}$, angle in degrees)

| Frequency | Mag S11 | Ang S11 | Mag S21 | Ang S21 | Mag S12 | Ang S12 | Mag S22 | Ang S22 |
|-----------|---------|---------|---------|---------|---------|---------|---------|---------|
| 500 MHz | 0.911 | -130.86 | 18.44 | 105.32 | 0.022 | 19.38 | 0.302 | -113.00 |
| 600 MHz | 0.906 | -139.86 | 15.82 | 99.40 | 0.023 | 14.28 | 0.299 | -120.56 |
| 700 MHz | 0.902 | -146.89 | 13.81 | 94.44 | 0.023 | 10.15 | 0.298 | -126.20 |
| 800 MHz | 0.900 | -152.58 | 12.23 | 90.14 | 0.023 | 6.68 | 0.299 | -130.51 |
| 900 MHz | 0.898 | -157.33 | 10.97 | 86.29 | 0.023 | 3.69 | 0.302 | -133.91 |
| 1.0 GHz | 0.897 | -161.38 | 9.93 | 82.79 | 0.023 | 1.03 | 0.305 | -136.65 |
| 1.1 GHz | 0.896 | -164.92 | 9.06 | 79.53 | 0.023 | -1.36 | 0.309 | -138.93 |
| 1.2 GHz | 0.895 | -168.07 | 8.33 | 76.47 | 0.023 | -3.55 | 0.314 | -140.86 |
| 1.3 GHz | 0.895 | -170.92 | 7.71 | 73.56 | 0.023 | -5.58 | 0.320 | -142.55 |
| 1.4 GHz | 0.895 | -173.52 | 7.17 | 70.77 | 0.023 | -7.47 | 0.326 | -144.06 |
| 1.5 GHz | 0.894 | -175.93 | 6.70 | 68.08 | 0.023 | -9.25 | 0.332 | -145.44 |
| 1.6 GHz | 0.894 | -178.19 | 6.29 | 65.47 | 0.023 | -10.93 | 0.338 | -146.73 |
| 1.7 GHz | 0.894 | 179.68 | 5.92 | 62.93 | 0.023 | -12.52 | 0.345 | -147.96 |
| 1.8 GHz | 0.894 | 177.66 | 5.60 | 60.44 | 0.023 | -14.04 | 0.351 | -149.13 |
| 1.9 GHz | 0.894 | 175.72 | 5.31 | 58.01 | 0.022 | -15.49 | 0.358 | -150.28 |
| 2.0 GHz | 0.894 | 173.85 | 5.04 | 55.62 | 0.022 | -16.88 | 0.365 | -151.42 |
| 2.1 GHz | 0.895 | 172.04 | 4.80 | 53.26 | 0.022 | -18.21 | 0.372 | -152.54 |
| 2.2 GHz | 0.895 | 170.28 | 4.59 | 50.93 | 0.022 | -19.48 | 0.379 | -153.66 |
| 2.3 GHz | 0.895 | 168.57 | 4.39 | 48.64 | 0.022 | -20.69 | 0.386 | -154.78 |
| 2.4 GHz | 0.895 | 166.88 | 4.21 | 46.37 | 0.021 | -21.85 | 0.393 | -155.92 |
| 2.5 GHz | 0.895 | 165.22 | 4.04 | 44.11 | 0.021 | -22.96 | 0.400 | -157.06 |
| 2.6 GHz | 0.895 | 163.58 | 3.88 | 41.88 | 0.021 | -24.02 | 0.407 | -158.21 |
| 2.7 GHz | 0.895 | 161.97 | 3.74 | 39.67 | 0.021 | -25.02 | 0.413 | -159.37 |
| 2.8 GHz | 0.896 | 160.36 | 3.61 | 37.47 | 0.020 | -25.97 | 0.420 | -160.55 |
| 2.9 GHz | 0.896 | 158.76 | 3.49 | 35.28 | 0.020 | -26.87 | 0.426 | -161.75 |
| 3.0 GHz | 0.896 | 157.17 | 3.37 | 33.11 | 0.020 | -27.72 | 0.433 | -162.96 |
| 3.2 GHz | 0.896 | 153.99 | 3.17 | 28.79 | 0.019 | -29.24 | 0.445 | -165.43 |
| 3.4 GHz | 0.896 | 150.81 | 2.99 | 24.49 | 0.019 | -30.53 | 0.456 | -167.97 |
| 3.6 GHz | 0.897 | 147.59 | 2.83 | 20.21 | 0.018 | -31.57 | 0.467 | -170.58 |
| 3.8 GHz | 0.897 | 144.34 | 2.69 | 15.94 | 0.018 | -32.35 | 0.477 | -173.26 |
| 4.0 GHz | 0.897 | 141.03 | 2.56 | 11.67 | 0.017 | -32.86 | 0.487 | -176.01 |
| 4.2 GHz | 0.897 | 137.66 | 2.45 | 7.39 | 0.017 | -33.08 | 0.496 | -178.84 |
| 4.4 GHz | 0.897 | 134.20 | 2.35 | 3.09 | 0.017 | -33.02 | 0.504 | 178.25 |
| 4.6 GHz | 0.897 | 130.65 | 2.26 | -1.24 | 0.016 | -32.67 | 0.511 | 175.25 |
| 4.8 GHz | 0.897 | 127.01 | 2.18 | -5.61 | 0.016 | -32.06 | 0.517 | 172.16 |
| 5.0 GHz | 0.896 | 123.25 | 2.11 | -10.03 | 0.016 | -31.23 | 0.523 | 168.97 |
| 5.2 GHz | 0.896 | 119.37 | 2.04 | -14.50 | 0.016 | -30.22 | 0.528 | 165.68 |
| 5.4 GHz | 0.896 | 115.36 | 1.98 | -19.04 | 0.016 | -29.11 | 0.532 | 162.26 |
| 5.6 GHz | 0.896 | 111.21 | 1.92 | -23.65 | 0.016 | -27.99 | 0.536 | 158.72 |
| 5.8 GHz | 0.895 | 106.92 | 1.87 | -28.34 | 0.017 | -26.98 | 0.539 | 155.04 |
| 6.0 GHz | 0.895 | 102.47 | 1.83 | -33.12 | 0.017 | -26.15 | 0.541 | 151.21 |

Download this s-parameter file in ".s2p" format at http://www.cree.com/products/wireless_s-parameters.asp

Product Dimensions CGH55015F2 (Package Type — 440166)



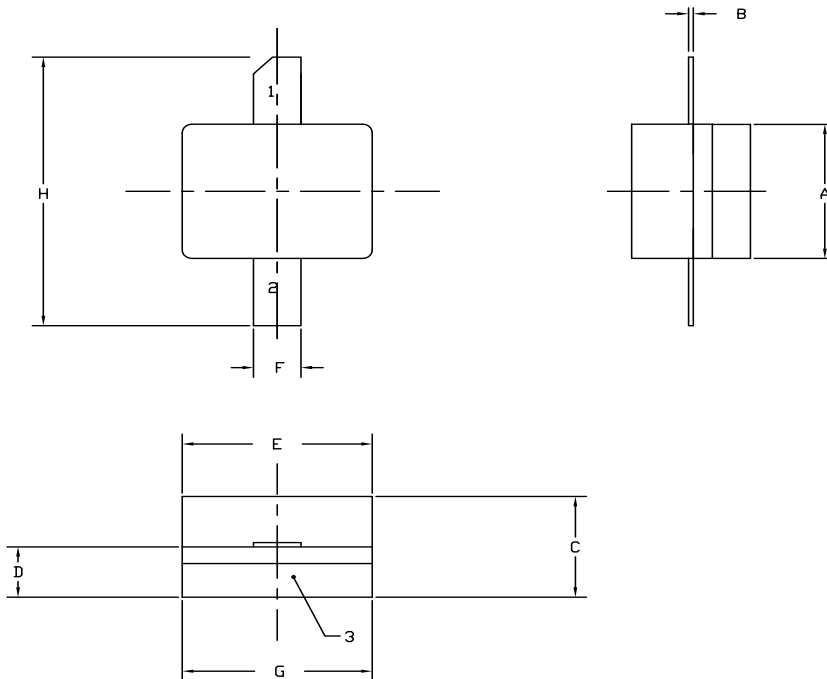
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
5. ALL PLATED SURFACES ARE NI/AU

| DIM | INCHES | | MILLIMETERS | |
|-----|--------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.155 | 0.165 | 3.94 | 4.19 |
| B | 0.004 | 0.006 | 0.10 | 0.15 |
| C | 0.115 | 0.135 | 2.92 | 3.43 |
| D | 0.057 | 0.067 | 1.45 | 1.70 |
| E | 0.195 | 0.205 | 4.95 | 5.21 |
| F | 0.045 | 0.055 | 1.14 | 1.40 |
| G | 0.545 | 0.555 | 13.84 | 14.09 |
| H | 0.280 | 0.360 | 7.11 | 9.14 |
| J | ∅ .100 | | 2.54 | |
| K | 0.375 | | 9.53 | |

- PIN 1. GATE
 PIN 2. DRAIN
 PIN 3. SOURCE

Product Dimensions CGH55015P2 (Package Type — 440196)



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
5. ALL PLATED SURFACES ARE NI/AU

| DIM | INCHES | | MILLIMETERS | |
|-----|--------|-------|-------------|------|
| | MIN | MAX | MIN | MAX |
| A | 0.155 | 0.165 | 3.94 | 4.19 |
| B | 0.003 | 0.006 | 0.10 | 0.15 |
| C | 0.115 | 0.135 | 2.92 | 3.17 |
| D | 0.057 | 0.067 | 1.45 | 1.70 |
| E | 0.195 | 0.205 | 4.95 | 5.21 |
| F | 0.045 | 0.055 | 1.14 | 1.40 |
| G | 0.195 | 0.205 | 4.95 | 5.21 |
| H | 0.280 | 0.360 | 7.11 | 9.14 |

- PIN 1. GATE
 PIN 2. DRAIN
 PIN 3. SOURCE



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- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
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- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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JONHON

«JONHON» (основан в 1970 г.)

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(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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